

# Innovating Energy Technology

http://www.fujielectric.com/products/semiconductor/ **FUJI POWER MOSFET** 

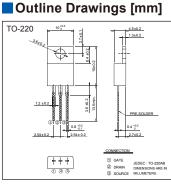
# **Super J-MOS series**

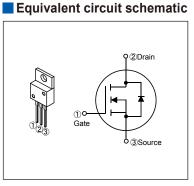
## N-Channel enhancement mode power MOSFET

### Features

Pb-free lead terminal **RoHS** compliant

Applications For switching





### Absolute Maximum Ratings at TC=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain Source Voltage	VDS	600	V	
Drain-Source Voltage	VDSX	600	V	V <sub>GS</sub> =-30V
Continuous Drain Current	Ι <sub>D</sub>	±8	А	Tc=25°C Note*1
Continuous Drain Current		±5.1	А	Tc=100°C Note*1
Pulsed Drain Current	IDP	±24	А	
Gate-Source Voltage	V <sub>GS</sub>	±30	V	
Repetitive and Non-Repetitive Maximum Avalanche Current	lar	2.5	А	Note *2
Non-Repetitive Maximum Avalanche Energy	Eas	249.6	mJ	Note *3
Maximum Drain-Source dV/dt	dV₀s/dt	50	kV/µs	V <sub>DS</sub> ≤ 600V
Peak Diode Recovery dV/dt	dV/dt	15	kV/µs	Note *4
Peak Diode Recovery -di/dt	-di/dt	100	A/µs	Note *5
Maximum Dawar Dissinction	Pp	2.02	W	T₂=25°C
Maximum Power Dissipation	<b>P</b> D	70	vv	Tc=25°C
Operating and Storage Temperature range	Tch	150	°C	
Operating and Storage Temperature range	T <sub>stg</sub>	-55 to +150	°C	

Note \*1 : Limited by maximum channel temperature.

 Note \*2: Teh≤150°C, See Fig.1 and Fig.2

 Note \*3: Starting Teh=25°C, IAs=1.5A, L=203mH, Vob=60V, Re=50Ω, See Fig.1 and Fig.2

 EAs limited by maximum channel temperature and avalanche current.

 Note \*4: Irs=1-n, edi/dt=100A/lys, Vob≤400V, Vpeak≤BVbss, Teh≤150°C.

 Note \*5: Irs=1-n, di/dt=15kV/µs, Vob≤400V, Vpeak≤BVbss, Teh≤150°C.

#### Electrical Characteristics at TC=25°C (unless otherwise specified) Dynamic Ratings

Description	Symbol	Conditions		min.	typ.	max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	I <sub>D</sub> =250μA V <sub>GS</sub> =0V		600	-	-	V
Gate Threshold Voltage	V <sub>GS(th)</sub>	I <sub>D</sub> =250µA V <sub>DS</sub> =V <sub>GS</sub>		2.5	3.0	3.5	V
Zero Gate Voltage Drain Current	loss	V <sub>DS</sub> =600V V <sub>GS</sub> =0V	T <sub>ch</sub> =25°C	-	-	25	-μA
		V <sub>DS</sub> =480V V <sub>GS</sub> =0V	T <sub>ch</sub> =125°C	-	-	250	
Gate-Source Leakage Current	Igss	V <sub>GS</sub> = ± 30V V <sub>DS</sub> =0V		-	10	100	nA
Drain-Source On-State Resistance	R <sub>DS(on)</sub>	I <sub>D</sub> =4A V <sub>GS</sub> =10V		-	0.399	0.47	Ω
Gate resistance	RG	f=1MHz, open drain		-	2.9	-	Ω

#### Dynamic Ratings

Description	Symbol	Conditions	min.	typ.	max.	Unit
Forward Transconductance	<b>g</b> <sub>fs</sub>	I <sub>D</sub> =4A V <sub>DS</sub> =25V	3.5	7.5	-	S
Input Capacitance	Ciss	V <sub>DS</sub> =10V	-	620	-	
Output Capacitance	Coss	V <sub>GS</sub> =0V	-	1340	-	
Reverse Transfer Capacitance	Crss	f=1MHz	-	120	-	
Effective output capacitance, energy related (Note *6)	C <sub>o(er)</sub>	V <sub>GS</sub> =0V V <sub>DS</sub> =0480V	-	48	-	pF
Effective output capacitance, time related (Note *7)	C <sub>o(tr)</sub>	V <sub>GS</sub> =0V V <sub>DS</sub> =0480V ID=constant	-	140	-	
td(on)	t <sub>d(on)</sub>	V <sub>DD</sub> =400V, V <sub>GS</sub> =10V/0V I <sub>D</sub> =4A, R <sub>G</sub> =30Ω See Fig.3 and Fig.4	-	9.5	-	- ns
Turn-On Time	tr		-	29	-	
Turn Off Time	t <sub>d(off)</sub>		-	75	-	
Turn-Off Time	tr		-	16	-	
Total Gate Charge	Q <sub>G</sub>		-	25	-	
Gate-Source Charge	Q <sub>GS</sub>	V₀₀=480V, l₀=8A V₀₅=10V See Fig.5	-	7.5	-	nC
Gate-Drain Charge	Q <sub>GD</sub>		-	6	-	
Drain-Source crossover Charge	Qsw		-	5	-	1

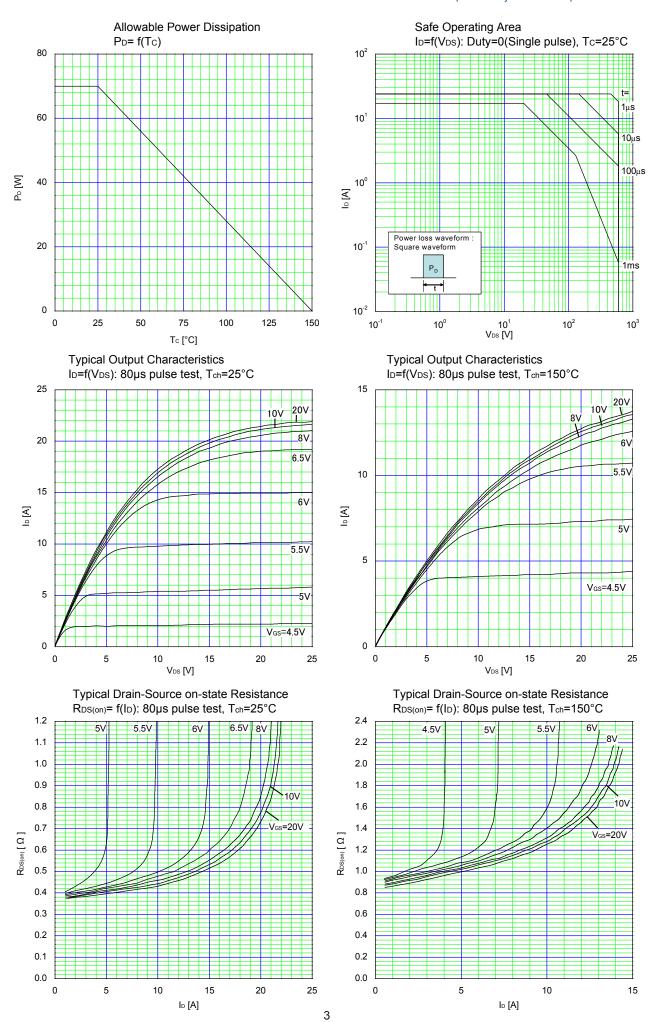
Note \*6 :  $C_{o(er)}$  is a fixed capacitance that gives the same stored energy as  $C_{oss}$  while  $V_{Ds}$  is rising from 0 to 80% BV<sub>Dss</sub>. Note \*7 :  $C_{o(tr)}$  is a fixed capacitance that gives the same charging times as  $C_{oss}$  while  $V_{Ds}$  is rising from 0 to 80% BV<sub>Dss</sub>.

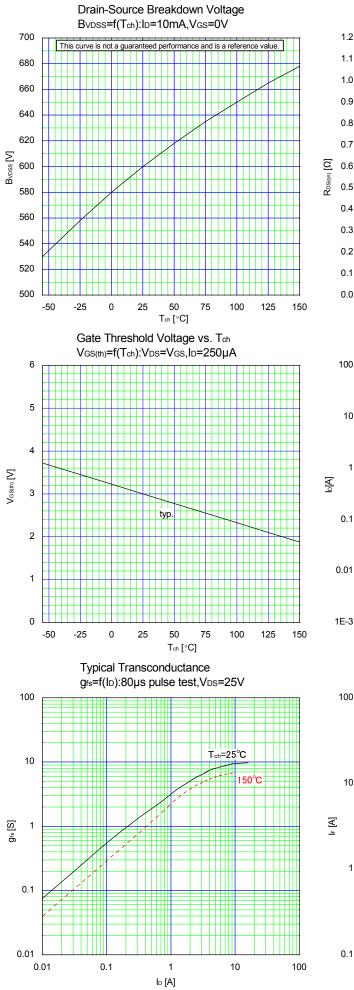
#### Reverse Diode

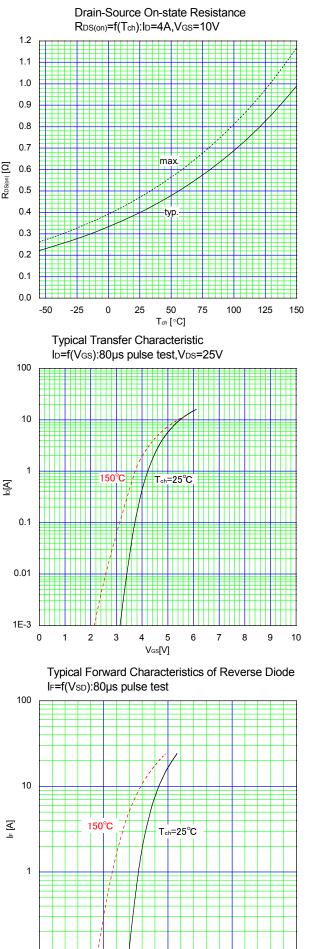
Description	Symbol	Conditions	min.	typ.	max.	Unit
Avalanche Capability	lav	L=43.9mH, T₀h=25°C See Fig.1 and Fig.2	2.5	-	-	А
Diode Forward On-Voltage	$V_{\text{SD}}$	I⊧=8A, V₀s=0V T₀h=25°C	-	0.9	1.35	V
Reverse Recovery Time	trr	$I_{\text{F}}=8A, V_{\text{DD}}=400V \\ -di/dt=100A/\mu s \\ V_{\text{GS}(01)}=short, V_{\text{GS}(02)}=10V/0V \\ R_{\text{G}}=330\Omega \\ T_{\text{ch}}=25^{\circ}\text{C} \\ \text{See Fig.6 and Fig.7}$		285	-	ns
Reverse Recovery Charge	Qrr		-	3.2	-	μC
Peak Reverse Recovery Current	Irp		-	20	-	А

#### Thermal Resistance

Parameter	Symbol	min.	typ.	max.	Unit
Channel to Case	R <sub>th(ch-c)</sub>	-	-	1.79	°C/W
Channel to Ambient	R <sub>th(ch-a)</sub>	-	-	62	°C/W







0.0

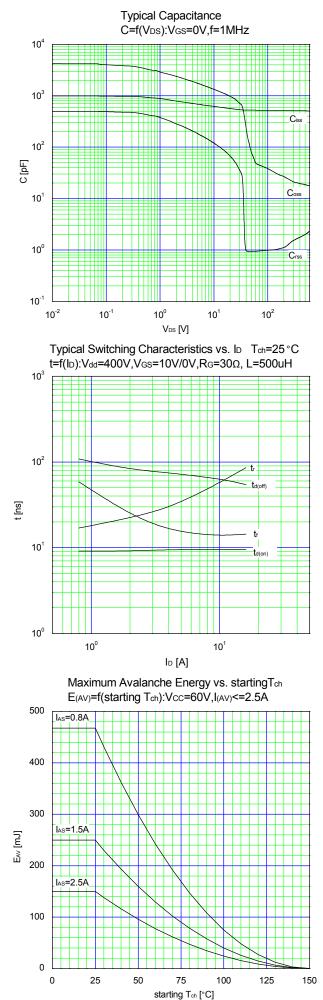
0.5

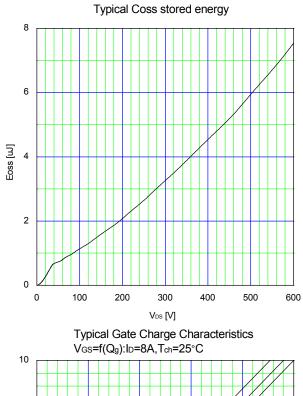
1.0

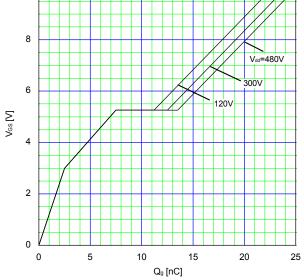
VSD [V]

1.5

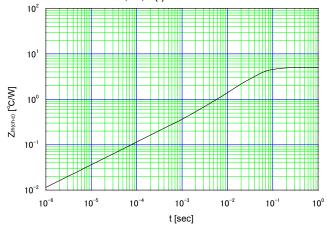
2.0







 $\begin{array}{l} \mbox{Transient Thermal Impedance} \\ Z_{th(ch-c)} \mbox{=} f(t) \mbox{:} D \mbox{=} 0 \end{array}$ 



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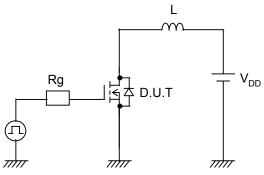
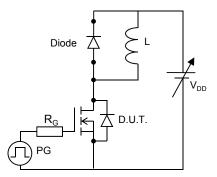


Fig.1 Avalanche Test circuit





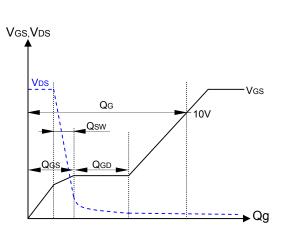


Fig.5 Operating waveform of Gate charge Test

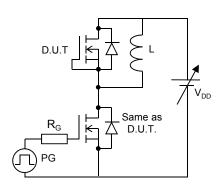


Fig.6 Reverse recovery Test circuit

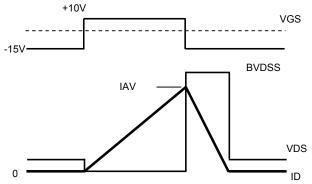


Fig.2 Operating waveforms of Avalanche Test

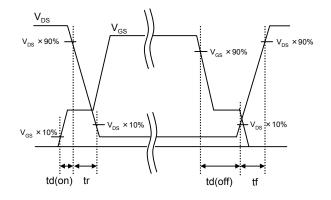


Fig.4 Operating waveform of Switching Test

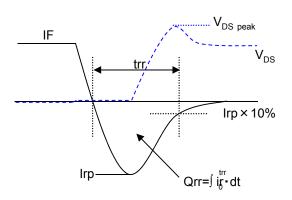
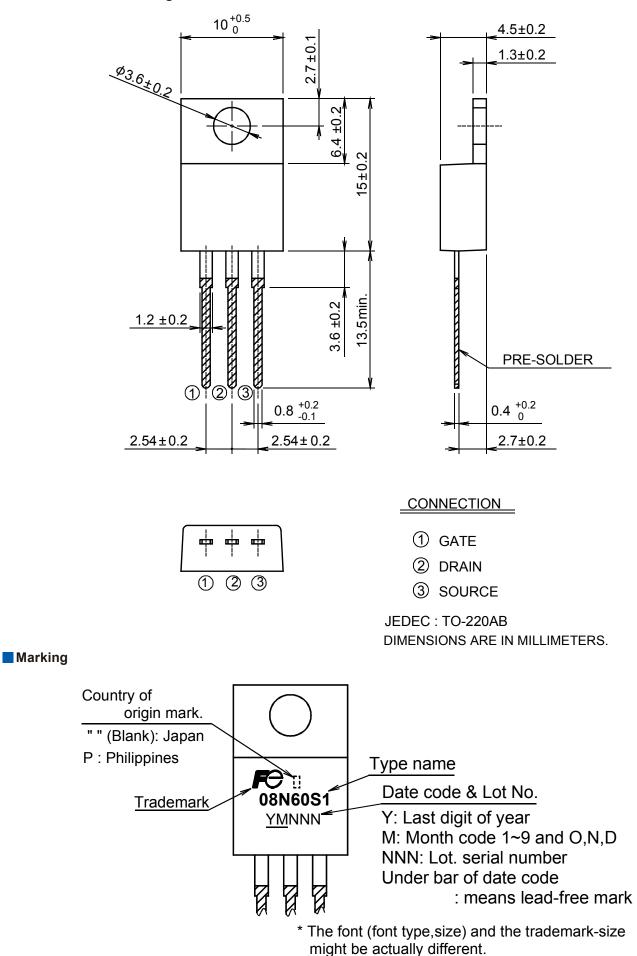


Fig.7 Operating waveform of Reverse recovery Test

#### Outview: TO-220 Package



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